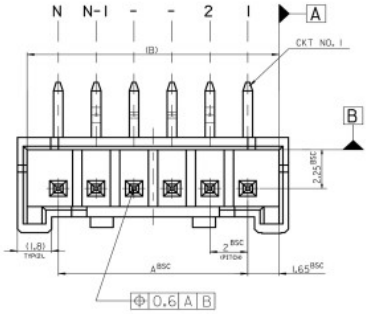
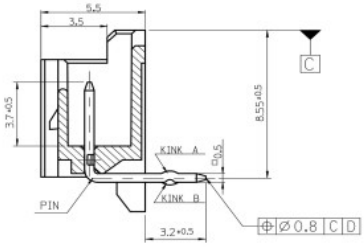
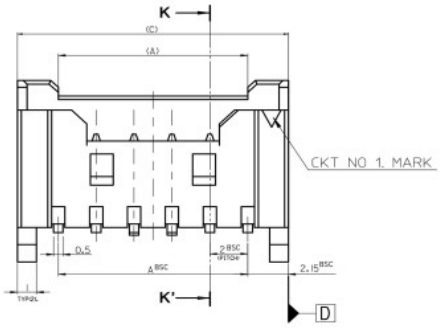
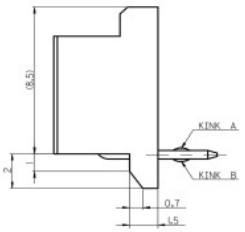
LEAD FREE





SECTION K-K'





NOTES
1. MATERIAL : WAFER - UNFILLED POLYAMIDE, UL94V-0
   PIN - BRASS C2700W
2. FINISHES : PIN - SN 2 ~ 3 MICROMETER OVERALL
3. PRODUCT SPECIFICATION : PS-35507-003
4. MATES WITH : HOUSING - 35507-**0*
   TERMINAL - 50212-8000
5. KINK

CKT NO / CKT	1	2	3	4	5	N-2	N-1	N
6 CKT OVER	—	A	B	—	—	B	A	—
5 CKT	A	B	—	B	A			
4 CKT	A	B	B	A				

30 over	±0.3
10 over 30 under	±0.25
10 under	±0.2
ANGLE	±3°

GENERAL TOLERANCE

REV	DESCRIPTION	
B	REVISED EC NO: KOR2012-0004	2011/07/11 2011/07/11 2011/07/26
	DRWN:HSKIM05 CHKD:KSKIM APPR:YUNSIKKIM	

QUALITY SYMBOLS
▼=0
Ⓒ=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR	±---°	

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY
SCALE: 5:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

DRAWN BY	YSOOKIM	DATE 1996/09/11
CHECKED BY	JKOH	DATE 1996/09/11
APPROVED BY		DATE

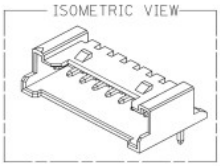
TITLE: 2.0 W/B WAFER R/A ASS'Y -LEAD FREE-

molex MOLEX INCORPORATED

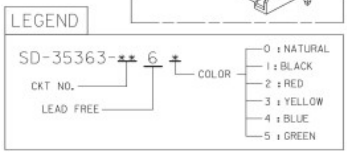
MATERIAL NO.: SEE TABLE
DOCUMENT NO.: SD-35363-002
SHEET NO.: 1 OF 3
SIZE: A3

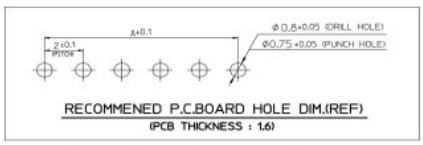
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

ISOMETRIC VIEW



LEGEND





RECOMMENED P.C.BOARD HOLE DIM.(REF)
(PCB THICKNESS : 1.6)

(C)	(B)	A	MATERIAL NO.	ENG. NO.	CKT
32.3	31.3	28	156*	- 156*	15
30.3	29.3	26	146*	- 146*	14
28.3	27.3	24	136*	- 136*	13
26.3	25.3	22	126*	- 126*	12
24.3	23.3	20	116*	- 116*	11
22.3	21.3	18	106*	- 106*	10
20.3	19.3	16	096*	-096*	9
18.3	17.3	14	086*	-086*	8
16.3	15.3	12	076*	-076*	7
14.3	13.3	10	066*	-066*	6
12.3	11.3	8	056*	-056*	5
10.3	9.3	6	35363046*	35363-046*	4